

HORUX

X-RAY AND REWORK STATION

By Solucinde

**X-Ray Counting Machine / X-Ray Inspection Equipment
Multifunctional BGA Rework Equipment One-stop Service**

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HX-100

X-Ray Counting Equipment Series

HX-100 is a full-automatic micro-focus X-ray counting machine.

It uses X-Ray flourescopy principle and independently developed algorithm software with AI fuction, which can quickly and accurately calculate the number of materials in the material reel.

It also has MES Data upload and automatic priting of material labels, which can achieve the function of improving work efficiency and saving manpower.

Product Features

- Compared with traditional counting/pointing machine, there is no need to unpack or transfer the reel.
- Suitable for all types of chip components, SMD components above 01005.
- Accuracy of counting reaches more than 99.99%, it can realize automatic counting.
- Countable reel diameter is 7-15 inches.
- Innovative detection enviroment and algorithm with AI function.
- Designed with reference to human mechanics, seated operation the monitor is at the same height as the human eye, protects the cervical spine, is not easy to fatigue, occupies a small space, and can be used in any position Compared with traditional counting/pointing machine, there is no need to unpack or transfer the reel.
- The platform automatically enters and exits, which is convenient for material taking, automatic platform grating induction, torque control, anti-pinch hand.
An error-proof mechanism for material labels, full induction recognition of material reels, real-time docking with printers, and printing of material information immediately if the reel is taken away.
- Connect with MES/ERP/WMS and other system data, real-time data interactive, timely upload and update of material information.
- Real-time database storage and MES data upload.
- Can recognize 1D or 2D codes.
- Four groups of cameras realize automatic scanning function (optional).
- The equipment automatically recognizes single or four-reel material.



Product Parameters

Model No.		HX-100
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	30-80KV
	Tube Current	200-700μA
	Maximum Output Power	56W
	Micro Focus Size	30-40μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	3072×3072
	Field of View	427mm×427mm
	AD Conversion Digits	16bits
Equipment Specifications	Reel Diameter	7"-15" Tape Reel
	Reel Height	<80mm
	Minimum Component	01005
	System Docking	MES/ERP/WMS
	Label Printing	TSC Industrial Printer
	Input Power	220V 10A 50-60HZ
	Operation System	Win7 (windows 10 is optional)
	Dimensions	L800mm×W128mm×H2200mm
	Net Weight	About 790KG

HX-200

X-Ray Counting Equipment Series

HX-200 is an automatic inline counting machine. It uses the X-ray fluorescence principle and the independently developed algorithm software with AI function, which can quickly and accurately calculate the material quantities in the reel, it can also upload MES data and automatically print the material labels. It has the functions of automatic code scanning, labeling, and automatic sorting failure, and can automatically load and unload materials to improve work efficiency and save manpower.



Product Features

- About 200 reels of materials can be placed at one time.
- 31 million pixel camera automatically scans barcode information and label position.
- 8-12 seconds/reel counting speed.
- TSC industrial printer automatically prints and labels.
- Connect with MES/ERP/WMS and other system data, and exchange data in real time.
- With automatic loading/unloading function.
- Compared with traditional counting/pointing machine, there is no need to unpack or transfer the reel.
- Suitable for all types of chip components, SMD components above 01005.
- Accuracy of counting reaches more than 99.99%
- Measurable reel diameter is 7-15 inches.
- Innovative detection environment and algorithm with AI function.
- With automatic sorting of defective products.
- With automatic printing and attaching material labels.

Product Parameters

Model No.		HX-200
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	30-80KV
	Tube Current	200-700μA
	Maximum Output Power	56W
	Micro Focus Size	30~40μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	3072×3072
	Field of View	427mm×427mm
	Resolution	3.6Lp/mm
	Image Frame Rate (1x1)	6fps
	AD Conversion Digits	16bits
Equipment Specifications	Reel Diameter	7"-15" Tape Reel
	Reel Height	<80mm
	Minimum Component	01005
	System Docking	MES/ERP/WMS
	Input Power	220V 10A 50-60HZ
	Operation System	Win10 optional 64 bits
	Dimensions	L3100mm×W1600mm×H2100mm
	Net Weight	About 2200KG

HX-560

X-Ray Inspection Series

HX-560 is a small precision micro-focus X-ray inspection equipment, which is suitable for R&D enterprise laboratories, offices, and quality laboratories etc., and is the first choice for X-ray inspection of tiny, small and medium precision components.

Product Features

- Miniaturized equipment, easy to install and use.
- Applied to the inspection of chips, BGA/CSP, wafers, SOP/QFN, SMT and PTU packages, sensors, etc.
- High-resolution design for the best possible image in a fraction of the time.
- Automatic infrared navigation and positioning, quickly select the shooting position.
- CNC inspection mode for fast automatic inspection of multi-point arrays.
- Multi-angle tilt inspection makes it easier to inspect sample defects.
- Software operation is simple and easy to use, low operating cost.
- Durable service life.



Tilt Photo/Rotate Photo Function

Tilt perspective detection function.

It has the function of tiling camera. For pictures taken from the front of a special device. If the detect features cannot be identified, the tiling camera function can be used to observe the features of the device from multiple angles, which is easier to analyze and identify the defect content.

360° rotation photo detection function.

Equipped with a rotating manipulator, it can rotate 360 degrees to take pictures, and there is no dead angle observation defect.

Product Parameters

Model No.		HX-560
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	40-90KV
	Tube Current	10-200μA
	Maximum Output Power	8W
	Micro Focus Size	15μm
Flat Panel Detector	Flat Panel Type	TFT Industrial Dynamic flat panel director
	Pixel Matrix	768×768/1536×1536
	Field of View	65mm×65mm/130mm×130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20-40fps
	AD Conversion Digits	16bits
Equipment Specifications	Input Power	220V 10A/110V 50-60HZ
	Operation System	Industrial Computer Win7 (Win10 optional) 64 bits
	Dimensions	L850mm×W1000mm×H1700mm
	Net Weight	About 750KG

HX-660T

X-Ray Inspection Series

HX-660T is a compact and cost-effective general purpose offline precision micro-focus X-ray inspection equipment. It has the characteristics of simple and concise structure, small footprint, simple operation, easy to learn and understand.

Product Features

- Simple operation, good maneuverability, and high cost performance.
- High-resolution design for the best possible image in a fraction of the time.
- Automatic infrared navigation and positioning, quickly select the shooting position.
- CNC inspection mode for fast automatic inspection of multi-point arrays.
- Multi-angle tilt inspection makes it easier to inspect sample defects.
- Software operation is simple and easy to use, low operating cost.
- With automatic calibration function.
- Simple structure and small footprint.
- Safe and reliable fingerprint input.
- Real-time monitoring of radiation value, multiple protection of operator's personal safety.
- Rocker mechanism, easy to operate and good maneuverability.

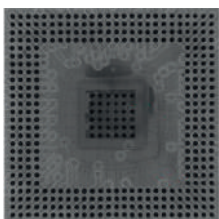


Product Parameters

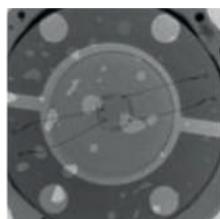
Model No.		HX-660T
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	40-90KV
	Tube Current	10-178μA
	Maximum Output Power	8W
	Micro Focus Size	7μm
Flat Panel Detector	Flat Panel Type	Flat Panel Type Amorphous Silicon Flat Panel Detector
	Pixel Matrix	768×768
	Field of View	65mm×65mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20-40fps
	AD Conversion Digits	16bits
Equipment Specifications	Input Power	220V 10A 50-60Hz
	Operation System	Industrial Computer Win7 (windows 10 is optional) 64 bits
	Maximum Sample Size	280mm×320mm
	Dimensions	L850mm×W1000mm×H1700mm
	Net Weight	About 750KG

Applications

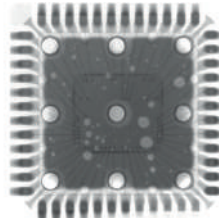
BGA Inspection



LED Inspection



QFP Inspection



Gold Wire Height Inspection



HX-660H

X-Ray Inspection Series

HX-660H is a cost-effective general-purpose offline precision micro-focus X-ray inspection equipment, suitable for the inspection of various types of factory offline products. It has the characteristics of high magnification, multi-angle inspection, and large-area inspection platform.

Product Features

- Meets general x-ray inspection needs, with a wide range of applications.
- High-resolution design to get the best image fast.
- Laser automatic navigation and positioning, quickly select the shooting position.
- CNC inspection mode for fast automatic inspection of multi-point arrays.
- Multi-angle tilt inspection makes it easier to inspect sample defects.
- Software operation is simple and easy to use, low operating cost.
- The X-ray tube and flat panel can be rotated at the same time (0-60°), making the inspection image cleaner and more intuitive.
- Real-time monitoring of radiation value, multiple protection of operator's personal safety.

Size Measurement

Measuring Tool:

Distance, distance ratio, line spacing, angle, arrow mark, circle radius, point distance, circle radius, point distance, circle center distance, perimeter, hand-painted polygon, hand-painted freeform, etc., can be added with text description.

Defect Inspection

Automatic Defect Recognition:

Equipped with a rotating manipulator, it can rotate 360 degrees to take pictures, and there is no dead angle observation defect.

Customizable Image Algorithm:

Develop specific software algorithms according to the customer's product characteristics and requirements. To realize the automatic defect recognition and inspection function, including the presence or abstinence, crack, broken line, offset, size, number and other recognition algorithms.



Automatic Void Ratio Calculation

Enhanced BGA Extending Inspection Function:

It can quickly select and mark a single soldering ball, or select the soldering balls to be inspected in a matrix, and can manually or automatically identify the BGA soldering balls and complete the inspection process and ensure accurate and reliable inspection results.

Product Parameters

Model No.		HX-660H
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	90 KV/130 KV
	Tube Current	10-200μA
	Maximum Output Power	8W
	Micro Focus Size	5~15μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536 × 1536
	Field of View	130mm × 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
Equipment Specifications	AD Conversion Digits	16bits
	Input Power	220V 10A/110V 15A 50-60HZ
	Operation System	Industrial Computer Win7 (Win 10 optional) 64 bits
	Maximum Sample Size	540mm × 440mm
	Dimensions	L1245mm×W1230mm×H1900mm
	Net Weight	About 1170KG

HX-660M/BM

X-Ray Inspection Series

HX-660M/BM is a six-axis universal offline precision micro-focus X-ray inspection equipment. It has the characteristics of high magnification, multi-angle, and large-area inspection platform. At the same time, it has one-button door opening and closing, and real-time monitoring of radiation conditions around the equipment to ensure the safety of the environment and operators.

Product Features

- The X and Y axes of the platform are driven by high-precision micro-focus X-ray inspection accuracy.
- With automatic calibration function.
- Real-time monitoring of radiation value, multiple protection of operator's personal safety.
- One-button automatic opening and closing of the movable door, convenient for personnel to work.
- Large inspection platform to ensure a wider range of equipment inspection sizes.
- Fingerprint verification.



Application Advantages

○ Rocker, Fingerprint, Radiometer, T-Axis To Take Pictures:

1. **Fingerprint:** Authorize someone to control the device.
2. **Rocker:** The X/Y axis running control key of the platform is easy to operate.
3. **Radiometer:** Monitor the radiation value in real time, if the set value is exceeded, the radiometer will automatically alarm, prompting the radiation state of the inspection equipment.
4. **T-axis tilt photo inspection:** When the conventional vertical inspection cannot meet the requirements, the T-axis tilt inspection function can be used, and the inspection range is more comprehensive.

CNC Automatic Running Inspection

- CNC Automatic Running Inspection: It can run CNC multi-point automatic inspection, and set multi-point coordinates for automatic inspection according to user product specifications.
- Automatic CNC running inspection can automatically store images, generate reports automatically, and perform batch inspection.

Product Parameters

Model No.		HX-660M/HX-660BM
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	40-90KV/40-130KV
	Tube Current	10-200μA/10-130KV
	Maximum Output Power	8W/39W
	Micro Focus Size	5 -15μm
Flat Panel Detector	Flat Panel Type	Amorphous Silicon Flat Panel Detector
	Pixel Matrix	1648×1648
	Field of View	160mm×160mm
	Resolution	5.1Lp/mm
	Image Frame Rate (1x1)	30fps
	AD Conversion Digits	16bits
Equipment Specifications	Input Power	220V 10A 50-60Hz
	Operation System	Industrial Computer Win7 (Win10 optional) 64 bits
	Dimensions	L1380mm×W1390mm×H1930mm
	Net Weight	About 1720KG / 1845KG

HX-760

X-Ray Inspection Series

HX-760 is a more powerful high-end precision micro-focus X-ray inspection equipment, which can realize multi-angle and multi-directional photography, can be upgraded to 2.5D inspection function, and can realize 360° rotation of the product and 60° tilt of the detector for 3D photography. No blind spot to observe product defects, so that quality problems have nowhere to hide.

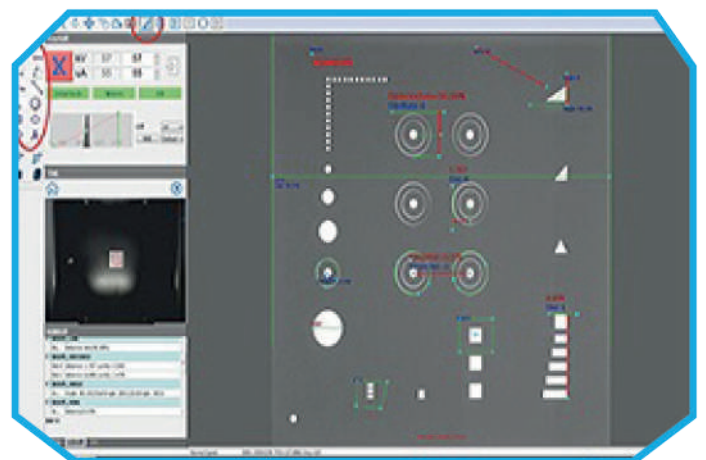
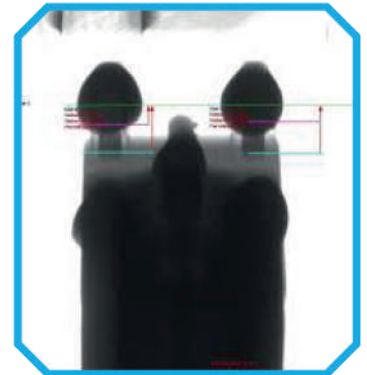
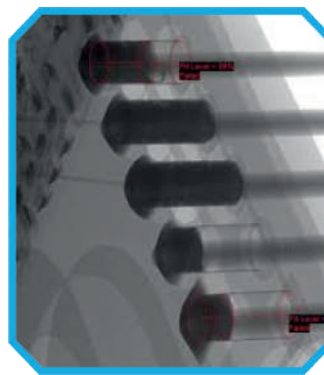
Product Features

- Observation at 60 degrees tilt.
- Upgradable 2.5D Module (Industrial CT) (Optional).
- High-definition inspection images: offset / soldering / voids / cold soldering / wire bonding.
- 360 degree platform rotation.
- Color image navigation & Mapping navigation.
- Support picture stitching function (optional).



Product Parameters

Model No.		HX-760
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	40-90KV/40-130KV
	Tube Current	10-200μA/10-300μA
	Maximum Output Power	8W/39W
	Micro Focus Size	5~15μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536 × 1536
	Field of View	130mm × 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
Equipment Specifications	Dimensions	L1700mm×W1770mm×H1800mm
	Input Power	220V 10A/110V 15A 50-60HZ
	Platform Size	500mm × 500mm
	Operation System	Industrial Computer Win7 (Win 10 optional) 64 bits
	Net Weight	About 1900KG



HX-1200

X-Ray Inspection Series

HX-1200 is a precise micro-focus X-ray inspection equipment for large-scale inspection of large PCB boards, 5G communication mainboards, and LED light strips. Its effective inspection area can reach 1200mm × 600mm, which can realize a wide range of automatic inspection, and accept customized services according to different product sizes.

Product Features

- Large inspection area 1200mm×600mm.
- X-ray source and detector X/Y motion cover inspection area.
- Can edit the inspection program by CNC to realize automatic inspection and judgment.
- Accept customized services according to different product sizes (optional).
- Automatic inspection program customization (optional).
- Software operation is simple and easy to use, low operating cost.

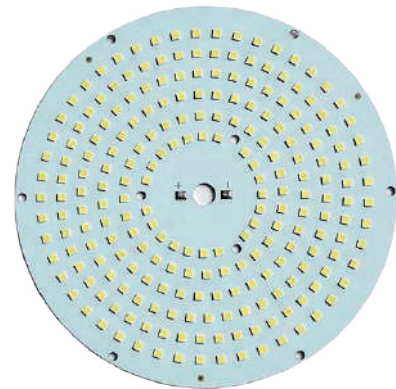
Product Parameters

Model No.		HX-1200
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage	40-90KV/40-130KV
	Tube Current	10-200μA/10-300μA
	Maximum Output Power	8W/39W
	Micro Focus Size	5-15μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536 × 1536
	Field of View	130mm × 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
Equipment Specifications	Input Power	220V 10A/110V 15A 50-60HZ
	Operation System	Industrial Computer Win7 (Win 10 optional) 64 bits
	Maximum Sample Size	600mm × 1200mm
	Dimensions	L2040mm×W1280mm×H1870mm
	Net Weight	About 2350KG

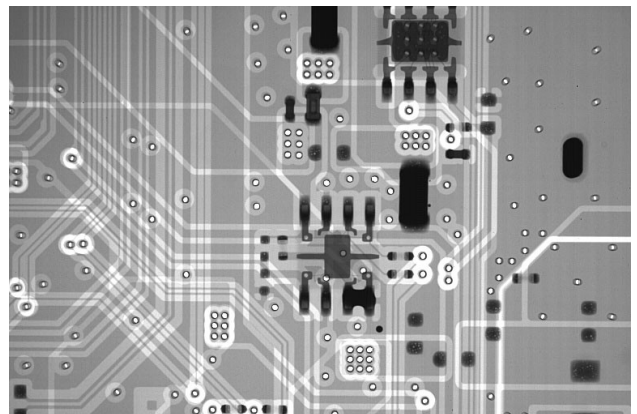


Application Cases

- LED Strip Inspection.



- PCB Board Inspection.



HX-5800L

AXI Hi-speed Inspection

HX-5800L is a small precision micro-focus X-ray inline inspection equipment, with inline automatic feeding, automatic inspection, automatic sorting, and the functions of punching or making defective products, suitable for coil and reel materials and production lines inspection of automatic feeding.

Product Features

- Miniaturized equipment, easy to install and use.
- Strong equipment compatibility, the conveyor belt can be adjusted in both directions.
- Servo feeding is stable and reliable.
- Software operation is simple and easy to use, low operating cost.
- Durable service life.
- Inline automatic inspection of equipment, automatic sorting and marking of defective products.
- Automatic inspection for various coils and reels.
- The equipment is compatible with the width of the reel.

Application Cases

- Triode Inline Inspection.
- IC Inline Inspection.
- Connector Inline Inspection.



Product Parameters

Model No.		HX-5800L
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro focus X-ray source
	Tube Voltage	40-90KV
	Tube Current	10-200μA
	Maximum Output Power	8W
	Micro Focus Size	15 μm
Flat Panel Detector	Flat Panel Type	Amorphous Silicon Flat Panel Detector
	Pixel Matrix	1536 × 1536
	Field of View	130mm × 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
Equipment Specifications	Input Power	220V 10A/110V 15A 50-60HZ
	Operation System	Industrial Computer Win7 (Win 10 optional) 64 bits
	Inspection Sample Width Range	30-150mm
	Dimensions	L1850mm×W1400mm×H1970mm
	Net Weight	About 1020 KG

HX-6500

AXI Hi-speed Inspection

HX-6500 is a SMT inline micro-focus X-ray inspection equipment for electronic assemblies.

Fully automatic judgment inspection is performed for the characteristic area of the PCB board or the specified device.

Product Features

- Fully automatic inline inspection of LED chip packaging.
- Automatic inline inspection of IGBT chips.
- IC BGA. Fully automatic in-line inspection of semiconductor devices, SMT and PTU packaging
- Automatic inline inspection of large size PCB boards and PCBA soldering points.
- Simple operation of template setting, guarantees safe operation.



Application Cases

- IGBT Module Inline Inspection.
- SMT Driver Board Inline Inspection.
- Inline inspection of tin penetration ratio of automotive power modules.
- LED light board inline detection.
- QR code inline inspection.
- Inline inspection of PCB drilling alignment.

Product Parameters

Model No.		HX-6500
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro focus X-ray source
	Tube Voltage	40-90KV/40-130KV
	Tube Current	10-200μA/10-300μA
	Maximum Output Power	8W/39W
	Micro Focus Size	5-15 μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536×1536
	Field of View	130mm×130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
Equipment Specifications	Input Power	220V 10A/110V 15A 50-60Hz
	Operation System	Industrial Computer Win7 (Win 10 optional) 64 bits
	Platform Size	510mm×650mm
	Dimensions	L1600mm×W1700mm×H2100mm
	Net Weight	About 2350 KG

HX-7800

AXI Hi-speed Inspection

HX-7800 is a SMT inline soldering quality inspection. Equipment for components such as automotive power control (MCU-ECU/I-GBT).

This equipment adopts COMET open X-ray tube design, and the defect inspection capability can reach 0.5um.

Product Features

- Fully automatic inline inspection in MCU-ECU/IGBT and other fields.
- Fully automatic inline inspection of PCB board and PCBA solder joints.
- Template setting is simple and easy to change.
- Strong penetration and high resolution.
- Flat panel 3D rotation 60°, parallel rotation 360°, 2.5D imaging.
- Support MES system customized access.
- Automatic Inline Inspection of automotive circuit boards and control boards.
- The software operation is simple and easy to use, and the system algorithm is powerful.
- Large equipment detection area, strong compatibility 480×500mm.
- Real-time monitoring of radiation value, multiple protection of operator's personal safety.

Application Cases

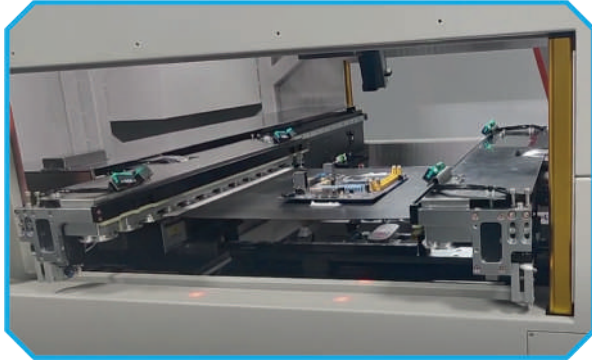
- IGBT Module Inline Inspection.
- SMT Driver Board Inline Inspection.
- Inline inspection of tin penetration ratio of automotive power modules.
- LED light board inline detection.
- QR code inline inspection.
- Inline inspection of PCB drilling alignment.



Product Parameters

Model No.		HX-7800
X-Ray Tube	X-Ray Tube Type	Open X-ray source
	Tube Voltage	160KV
	Tube Current	0-1000μA
	Maximum Output Power	10W
	Micro Focus Size	< 1 μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536 x 1536
	Field of View	130mm x 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
	Input Power	220V ± 10% 50-60Hz
Equipment Specifications	Operation System	Leadstart Industrial Computer Win7 (Win 10 optional) 64 bits
	Dimensions	L1870mmxW2150mmxH2300mm
	Net Weight	About 4950 KG

The core features of the transmission mechanism

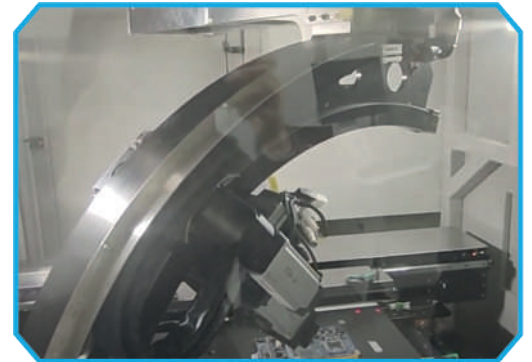


- Wide adjustment of loading guide rail width, can inspect products with 480x500mm.
- The loading guide rail has good flexibility, it can not only move left and right, forward and backward, but also change its own conveying direction according to the direction of the assembly line, that is, it can be left in and right out, or right in and left out.
- Loading guide rail can carry 30KG load.
- High-precision lead screw is used for the conveying of the loading guide rail.
- All power axis are driven by servo motors.

360 Rotation Observation Mode

- Convenient 360° fixed-point observation mode.
- 360° inline inspection without dead angle.
- Large rotation angle of the mechanism, strong equipment compatibility.
- 2D void inspection software module.
- 3D measurement and analysis software modules.

From the motion trajectory of each axis of the mechanism, we can see that this mechanism is aimed at different plug-ins on various PCB boards and different internal structures and components of the PCB board. Taking the inspection image from a single angle will cause interference or ghosting, resulting in misjudgment, or can not be customized for inspection, and this mechanism can shoot inspection, and judgment without dead angle, which greatly improves the core function and compatibility of the device.



Intelligent Micro-Focus X-Ray Source Technology with FeinFocus solutions, the best resolution of the smallest defects and the clearest internal structures are obtained

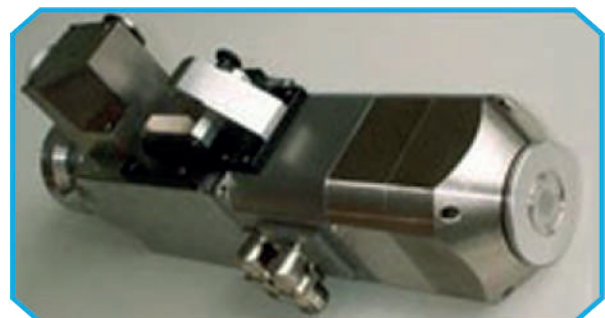
Comet Micro-focus Open X-ray Core Features

This equipment uses Comet's micro-focus open X-ray source, which has the characteristics that the larger the magnification, the stronger the ability to see the smallest defects of the object. The X-ray inspection system enlarges the image of the object to find the subtleties defect. For example, a 1-micron defect must be magnified more than 500 times to be seen by the human eye.

High Resolution, Support Inline Inspection

Main parameters of high resolution & high power target

- Cover a 2um tungsten layer on the 250um heat dissipation material. Replaceable and rotatable to extend service life, the maximum target power is 15W.
- Minimum focus-to-object distance 0.25 mm. High resolution & high power. Target and MFT tube, perfect combination.
- The target power is less than 1W, and the minimum defect inspection capability is 0.5um, which can be used for nano-scale defect inspection.
- Using negative feedback control technology to continuously control the intensity of X-rays.
- Output stable X-ray intensity for a long time.
- Ensures that image quality does not change with external environmental influences.



IHX-900

AXI Hi-speed Inspection

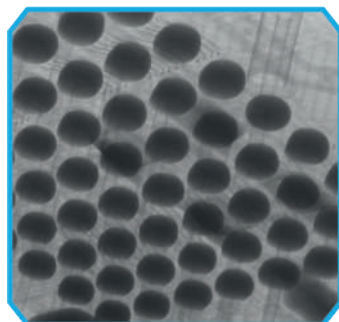
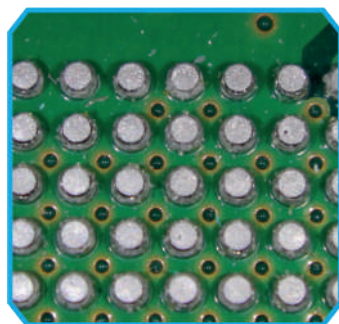
Application Cases

The inspection objects include BGA, QFP, SOP, CSP, CHIP, QFN, plug-in components, power modules and other components. Defects such as tin less, offset, bridge, voids, pillow effect, etc. (selected according to the

Product Features

- Unique 3D/CT reconstruction algorithm, reconstruction time is less than 30s (resolution 5um).
- High-speed automatic inspection technology, using linear motor three-layer gantry structure to achieve high-speed 3D/CT scanning.
- According to user needs, scan the sample (or components) in whole or in part.
- The minimum measurable 0.3mm pitch and banding line images over 0.2mm are clearly distinguishable.

Internal Solder Ball Defects



Product Parameters

Model No.		IHX-900
X-Ray Tube	X-Ray Tube Type	Reflective sealed micro-focus X-ray source
	Tube Voltage Range	40-130KV
	Tube Current Range	10-300μA
	Maximum Output Power	39W
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536 x 1536
	Field of View	130mm x 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
PCB Size	Maximum panel size	610 x 510mm
	Minimum panel size	50 x 50mm
	Maximum inspectable area	600 x 500mm
	Maximum panel thickness	10mm
	Minimum panel thickness	0.5mm
	Maximum panel weight	10 Kg
	Board top clearance	60mm
	Board bottom clearance	45mm
	X-Ray Leakage	<1μSv/h
Equipment Specifications	Air Pressure	0.45~0.65MPa
	Input Power	220V 10A 50-60Hz
	Operation System	DELL Precision T5820 Image Workstation
	Dimensions	L2470mmxW2000mmxH2100mm
	Net Weight	About 7500 KG

HX-850CT

AXI Hi-speed Inspection

Universal X-Ray Inspection System

HX-850CT adopts COMET's open X-ray tube design, and its defect inspection capability can reach 0.5um. It can realize 2D/3D/CT and other inspection methods, and is suitable for quality inspection, 3D measurement and non-destructive

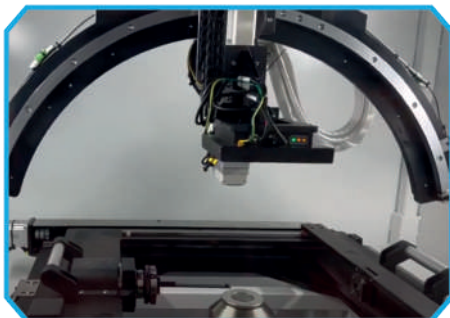
Application Advantages

- With planar CT function (PCT), it can be applied to 3D/CT inspection of printed circuit boards, SMT, IGBT, wafers, etc.
- With cone beam CT function, it can be applied to the inspection of sensors, relays, micro motors, materials and aluminium castings.
- Convenient 360° fixed-point observation mode.
- 2D void inspection software module (optional).
- 3D measurement and analysis software module (optional).

Application Fields

- Soldering quality inspection of solder joints on PCB, BGA components, integrated circuits (IC) and their bond wires inspection, semiconductor package inspection and internal connection, electronic power (IGBT) module inspection, Wafer defect inspection (WLCSP).
- Inspection of sensors, relays, fuses, coils, micro drive systems and air bag control systems, micro motors (MEMS, MOEMS), cables and plugs, plastic parts, various materials such as plastics, ceramics, biological materials, optical components, small titanium and aluminium castings.

360° Rotating Observation Mode



Product Parameters

Model No.		HX-850CT
X-Ray Tube	X-Ray Tube Type	Open Microfocus Transmitted Ray source
	Tube Voltage Range	25-160KV
	Tube Current Range	0.01mA~1.0mA
	Maximum Tube Power	64W
	Maximum Target Power	10W
	Micro Focus Size	<1μm
Flat Panel Detector	Flat Panel Type	Amorphous silicon flat panel detector
	Pixel Matrix	1536 x 1536
	Field of View	130mm x 130mm
	Resolution	5.8Lp/mm
	Image Frame Rate (1x1)	20fps
	AD Conversion Digits	16bits
Equipment Specifications	Maximum Sample Size	750mmx650mm
	Maximum Inspection Area	550mmx550mm
	Image Geometric Magnification	2000X
	Input Power	220V 10A 50-60Hz
	Operation System	DELL Precision T7920 Image Workstation
	Dimensions	L1600mmxW1700mmxH2000mm
	Net Weight	About 2950 KG

HX-820FT

AXI Hi-speed Inspection

High-Resolution X-Ray 3D Fluoroscopy Inspection System



Product Features

HX-820FT is a high-resolution horizontal CT system.


It adopts COMET's open X-ray tube design, and its defect inspection capability can reach 0.5um.

It can realize 3D and cone beam CT inspection methods, and is suitable for quality inspection, 3D measurement and non-destructive analyze. Equipped with high-precision of samples of different sizes


Equipment Specifications	Input Power	AC380V±10% 50-60Hz
	Control System	DELL Precision T7920 Image Workstation
	Dimensions	L3350mmxW1800mmxH2500mm
	Net Weight	About 8350KG

Product Parameters

Model No.		HX-820FT
X-Ray Tube	X-Ray Tube Type	Open Microfocus Transmitted Ray source
	Tube Voltage Range	25-160KV/20-225KV(Optional)
	Tube Current Range	0.01mA~1.0mA/3.0mA
	Maximum Tube Power	64W/320W
	Maximum Target Power	10W/280W
	Micro Focus Size	<1μm/<6μm
	Minimum Defect Inspection Capability	<500W/4μm
Flat Panel Detector	Flat Panel Type	Amorphous Silicon Flat Panel Detector (Optional)
	Pixel Matrix	1536 x 1536
	Field of View	154mm x 154mm
	Resolution	5Lp/mm
	Image Frame Rate (1x1)	60fps
	AD Conversion Digits	16bits
3D/CT Parameters (Optional Function)	CT Scan Cycle	10mm
	CT Reconstruction Time	60s

A decorative graphic on the left side of the page, consisting of a complex network of gray lines and circles that resemble a circuit board or a digital data path. The lines are of varying thickness and connect various circular nodes, some of which are larger than others. The pattern is dense and occupies the left half of the page.

SMART BGA REWORK EQUIPMENT

A horizontal blue line that starts with a small blue circle on the left and extends across the width of the text block.

Fully automatic visual BGA rework station, automatic high-end BGA rework station, large BGA rework station, smart BGA rework station.

HR-865

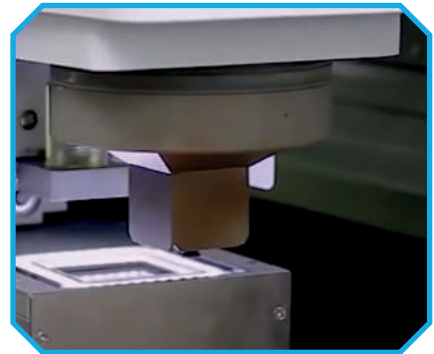
Smart BGA Rework Equipment

Smart BGA Rework Station

HR-865 is a BGA rework station with automatic visual alignment. It is suitable for automatic rework of various SMD devices on large PCB boards (such as 5G communication boards). It can realize automatic visual placement, automatic soldering, full automatic rework. Automatic desoldering function. It can be connected with MES software (optional) to realize the functions of temperature curve analysis with S/N as the traceability condition.



Precise Visual Alignment



Two sets of high-definition industrial cameras are used, and the repeat placement accuracy reaches $\pm 0.01\text{mm}$. The 5 million pixels high-definition industrial camera system is for accurate measurement and positioning of the chip, the automatic vision software system automatically corrects the angle, and the image is displayed in HD.

ESD Ionizer



Equipped with ionizer, which effectively eliminates static electricity on the board and protects the product.

Multifunctional Control Feature

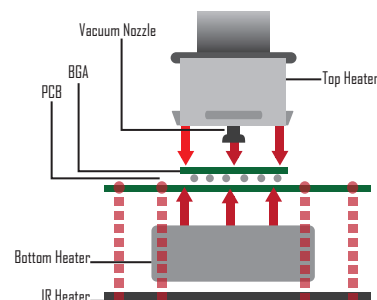
The self-developed software realizes fast positioning and stable temperature curve (with curve analysis function), easy operation and setting, and it can automatically generate record files to achieve traceability of historical parameters.



The operation interface is simple and fast, and a professional operation interface (system parameter setting, working mode setting, heating parameter setting, data recording, etc.) is set for different product characteristics, and there are Chinese and English interfaces to choose.

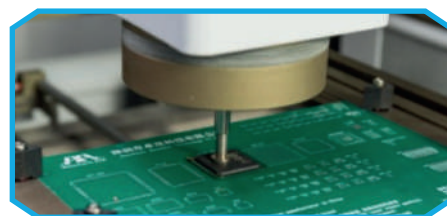
Three Independently Programmable Heating Zones

Three heating zones independently programmed and controlled; convection hot air heating in the top heater and de bottom, the heater adopts a large area heating wire layout, suitable for the repair of larger BGA, and the infrared preheating zone uses the German imported medium wave ceramic infrared heating Plate heating. The area can reach 645×524mm.



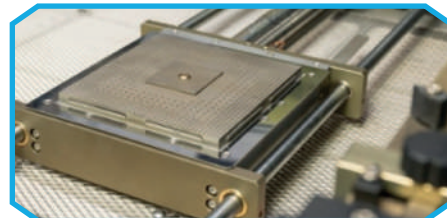
Stable Temperature Control

High-precision K-type thermocouple with accuracy up to $\pm 1^{\circ}\text{C}$, dynamic PID multiloop closed control selective reflow soldering process. With intelligent temperature compensation, and automatic memory function.



Bottom Heating System

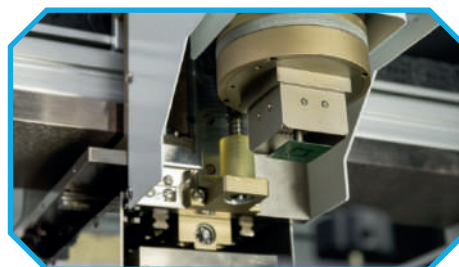
The bottom preheating adopts the heating plate imported from Germany, and the built-in temperature measuring probe is more accurate, which effectively solves the heating temperature control effect. The bottom moving temperature zone automatically moves with the head to improve the board rework efficiency.



Product Parameters

Model No.	R8650C
Power Supply	AC380 \pm 10% 50/60 Hz
Power	Total power 22KW Upper temperature (2KW) Lower temperature zone (2KW) Preheating temperature zone (16KW) Other power (2KW)
PCB Size	660×600mm(Max) ; 10×10mm(Min)
BGA Chip Size	100×100mm(Max) ; 1×1mm(Min)
IR Temp. Zone Size	640×520mm
Motion Control	X/Y/Z
External Temp. Sensor	8PCS
Control System	Industrial PC+Servo motion control system
Display System	24" SD display
Alignment System	2 million visual alignment system
Vacuum adsorption	Full automatic
Alignment Accuracy	$\pm 0.025\text{mm}$
Temp. Control	K-type thermocouple (closed-loop), intelligent temperature compensation system with accuracy up to $\pm 1^{\circ}\text{C}$
Feeding Device	Semi-automatic
Positioning	L-groove with universal fixture (shaped fixture can be customized)
Dimensions	L1235×W1215×H1850mm
Weight	993.5KG

Precise Motion Platform



It adopts industrial PC and servo motion control system to accuracy control the X/Y/Z four-axis gantry structure to operate fully automatically and independently. It adopts a gridding marble platform and a precise gridding screw. The visual accuracy can reach $\pm 0.01\text{mm}$.

Large Precise Rework Station

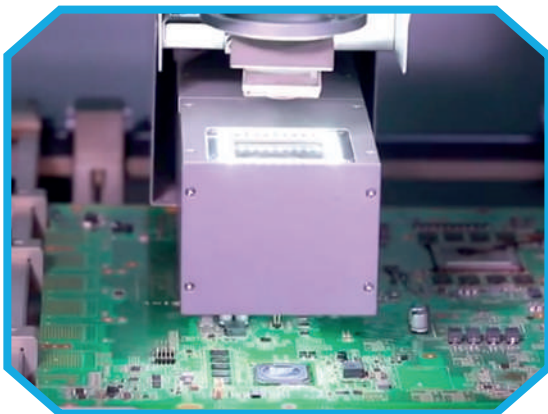
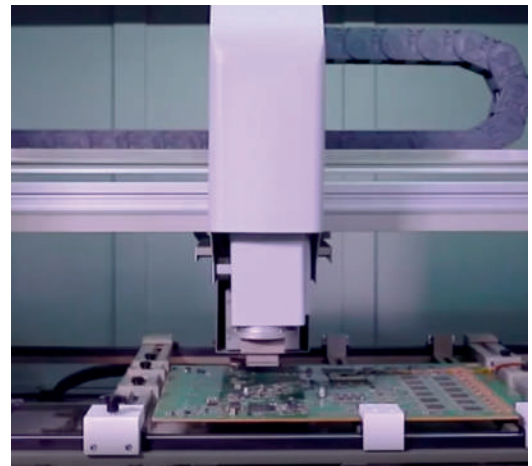


Large Area Preheating Platform

Independent three-temperature zone, the upper temperature zone uses ceramic heaters, the preheating zone adopts German imported medium-wave ceramic infrared heating plates, each plate can be controlled independently, and the preheating area can be adjusted according to the PCB board size. The large heating area of 850 * 580mm is suitable for the repair of larger PCB boards. The preheating zone automatically adjusts the distance from the PCB board to achieve the best performance.

HD Optical Inspection Module

Imported HD CCS (2m pixels) optical alignment system, which automatically moves the optical lens alignment through PC control servo system. 17 dual screens are used to display the alignment effect and operation interface respectively. The alignment function does not interfere with the operating system and the operation is convenient.

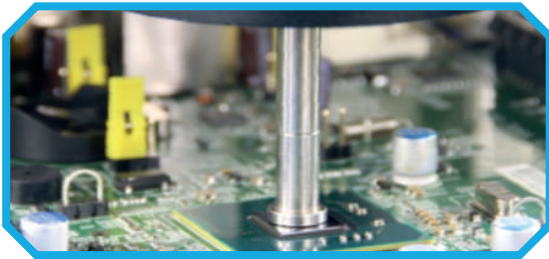


Self-Tuning Temperature Curve

Industrial PC and servo motion control system for precise control, with multiple operating modes, real-time display and editable of temperature curves, each curve can be set to more than 12 segments, curve analysis can be performed automatically, and temperature curves can be automatically generated into massive log files and saved, which are convenient to recall the historical parameters and trace the abnormal quality. With over-temperature protection and alarm function, the software can be encrypted and foolproof.

Automatic Feeding and Adsorption

The heating has a built-in vacuum tube for chip adsorption, electrically controlled 360 degree rotation alignment, with negative pressure monitoring, and automatic feeder device to realize automatic feeding and automatic receiving. With memory function, it can complete the desoldering and adsorption of the with one key, and the operation is simple.



High-performance, Multi-loop Heating System

External uses 5-channel temperature measurement interface, internal adopts high-precision K-type thermocouple with accuracy up to $\pm 1^{\circ}\text{C}$, it has dynamic PID multi-loop closed control selective reflow soldering process. At the same time, it can be connected with nitrogen heating to protect PCBA from oxidation and yellowing. Flowmeter negative pressure is precisely adjusted.

Product Parameters

Model No.	HR-800B
Power Supply	AC380V \pm 10% 50/60 Hz
Power	Total power (29KW) Upper temperature (2KW) Lower temperature zone (2KW) Preheating temperature zone (23.2KW) Other power (1.8KW)
PCB Size	800 \times 660mm(Max) ; 10 \times 10mm(Min)
BGA Chip Size	80 \times 80mm(Max) ; 2 \times 2mm(Min)
IR Temp. Zone Size	850 \times 580mm
Motion Control	X/Y/Z
External Temp. Sensor	5 PCS
Control System	Industrial PC+Servo motion control system
Display System	17 "HD industrial display (1080 P16 : 9) + 17 "SD display
Alignment System	2M pixels HD digital imaging system, automatic optical zoom, laser red-dot indicator.
Vacuum adsorption	Automatic
Alignment Accuracy	$\pm 0.025\text{mm}$
Temp. Control	K-type thermocouple closed-loop control with accuracy up to $\pm 1^{\circ}\text{C}$
Feeding Device	Yes
Positioning	L-groove with universal fixture (shaped fixture can be customized)
Dimensions	L1620 \times W1370 \times H1950mm
Weight	840.5KG

Large Precise Rework Station

HR-800D is a ultra-large high end optical alignment precise rework station, suitable for rework of 5G servers and large switch mainboards.



Product Features

- The whole machine is fully ESD protected, and complies with ESD protection standards.
- The safety design of the whole machine complies with the safety design specifications of GB / T15706-2012, and the relevant safety design requirements of GB / T1967 bimanual installation.
- The heating area is independently temperature controlled, and the process temperature can be designed according to the requirements, effectively avoiding PCBA deformation caused by uneven temperature, dual-protecting the heating power devices, and preventing the damage maintenance products caused by temperature's out of control.
- With drawer loading design, the stage can be stretched out, which is convenient for picking and placing the maintenance substrate.
- Using self-innovated image alignment technology can effectively solve the problem of visual alignment of large-size objects.
- The self-developed multi-function foolproof operating system is easy to operate and can be connected with MES / SAP.
- Equipped with a high-power silent smoke extraction system, the flux volatile gas generated during the PCBA rework process can be extracted and discharged in time.

Product Parameters

Model No.	HR-800D
Power Supply	AC380V±10% 50/60Hz
Total Power	33.8KW Max
Heating Power	Upper temperature zone(2KW) Lower temperature zone(2KW) IR temperature zone(28KW) Other power(1.8KW)
Control System	Industrial PC + servo motion control system
Alignment Accuracy	±0.25mm(X,Y axis)
Temp. Control	K type thermocouple closed-loop control with accuracy up to ±1°C/S
Heating Method	Top heating+Bottom heating+Mobile IR heating
External Temp. Sensor	6PCS
Positioning	L-groove with universal fixture (shaped fixture can be customized)
PCB Size	850×660mm (Max); 50×50mm (Min)
Temperature control	Full closed-loop control, temperature overshoot / fluctuation does not exceed 5°C, can automatically monitor the heating working status.
Cooling	Wind cooling
Cooling Rate	Rapid cooling, 200-100°C single board cooling rate 0.8-1°C/S
Mounting Pressure	<5N
Dimensions	L1671×W17771×H1928mm
Weight	929KG

Super Large Board Disassembly Preheating Platform

HR-900 super large preheating platform is suitable for the rework of surface mounting devices for 5G and other large servers.

Independent Dual-heating Zone Temperature Control System

HR-900 can be heated from the top of the components, supplemented by large-area infrared heating, can quickly solder various surface mounting devices, freely select through software for top or bottom heating energy, which can be quickly preheat to the specified temperature detection, and analyze and calibrate the temperature curve of the actual collected rework devices in real time.

Temperature Control

HR-900 temperature control adopts high-precision controller, K-type thermocouple closed-loop control and smart temperature compensation system. The bottom and sides of the heating table are equipped with heat dissipation system, which can control the temperature curve more accurately. The top heating device is designed independently, and the alignment point and heating point are manually controlled to achieve fixed-point heating.



Soldering Flux Smoke Extraction System

Equipped with a high-power silent smoke extraction system, the flux volatile gas generated during the PCBA rework process can be extracted and discharged in time.

Product Parameters

Model No.	HR-900
Power Supply	AC380V±10% 50/60Hz
Total Power	21.5KW Max
Heating Power	Top heater 1.5KW Bottom heater 19.2KW Other 0.8KW
Heating Temp.	Top temp. 550°C max Bottom temp. 400°C max
Temp. Control	K type thermocouple closed-loop control with accuracy up to ±1°C
PCB Size	850×700mm (Max) ;100×50mm (Min)
Heating Area	780×520mm
External Temp. Sensor	4 PCS
Dimensions	L1500×W960×H1970mm
Weight	438.5KG

Desktop Precise Rework Station



Product Features

- The safety design of the whole machine complies with the safety design specifications of GB / T15706-2012, and the relevant safety design requirements of GB / T19671 bimanual installation;
- Independent temperature control of the heating area, the process temperature can be designed according to the requirements, and the deformation and warpage of the PCBA caused by the uneven temperature can be effectively avoided;
- Equipped with a high definition external camera, which can clearly observe the melting status of the product;
- High-precision hardware and self-innovative visual alignment software algorithm make the product fit perfectly;
- Equipped with a cooling system with large air volume, so that the cooling rate of the solder joint temperature can reach: $1.0^{\circ}\text{C/s} \leq \text{Slope} \leq 3.0^{\circ}\text{C/s}$;
- Automatic flux scraping device, automatic dipping flux;
- All fans and blowers have the ability to remind and alarm when overloaded or blocked;
- Key parameter collection: equipment system version, product program version, suction power, top main heating temperature, bottom main heating temperature, top main heating air volume, bottom main heating air volume;
- Operator login information, program operation records and temperature curves can be automatically saved, and the records can be traced;
- The heating device adopts a double protection mechanism, it will automatically alarm when the top/bottom heating wire is blown/invalid, preventing the phenomenon that the product is damaged due to the sensor failure.

Product Parameters

Model No.	HR-790
Power Supply	AC380V \pm 10% 50/60Hz
Power	Power: Total power 9.05KM upper hot air (1KW) preheating zone (7.2KW) others (0.85KW)
PCB Size	400 \times 400mm (Max) ; 80 \times 80mm (Min)
Applicable Chip.	45 \times 45mm (Max) ; 7 \times 7mm (Min)
IR Temperature Zone Size	400 \times 400 \pm 10mm
External Temp. Sensor	6PCS
SMD pressure	<5N
SMD accuracy	\pm 0.05mm
Control System	Industrial PC + motion control system
Temperature Control	K-type thermocouple closed-loop control, temperature accuracy range of 1 $^{\circ}$ C
Stroke Accuracy	\pm 0.02mm
Dimensions	L890 \times W730 \times H750 mm
Weight	148 KG

Optical Alignment Automatic Rework Equipment



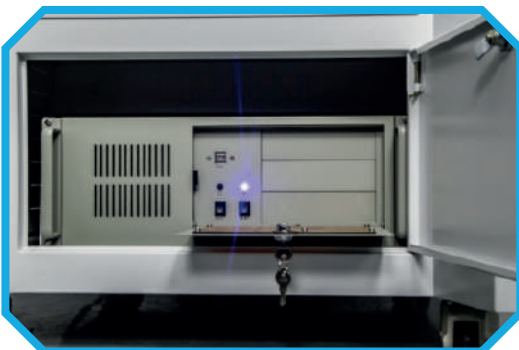
Convenient Temperature Setting and Saving

Three temperature zones, independently controlled by programming, convenient and quick setting of temperature parameters and temperature saving records, the top zone uses ceramic heaters, built-in vacuum tube is used for chip adsorption, electric control 360 degree rotation alignment, with pressure protection device, dual over-temperature protection and alarm function, software design has encryption and foolproof functions.



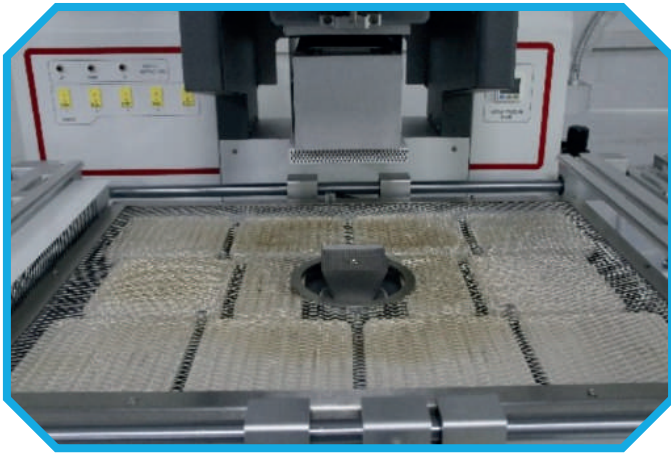
Multifunctional Control Features

Industrial PC control, it can set a variety of operating modes, real-time display of temperature curve, each curve can be set to more than 12 segments, it can automatically analyze the curve, to generate a large number of log files to facilitate the recall of historical parameters for traceability.



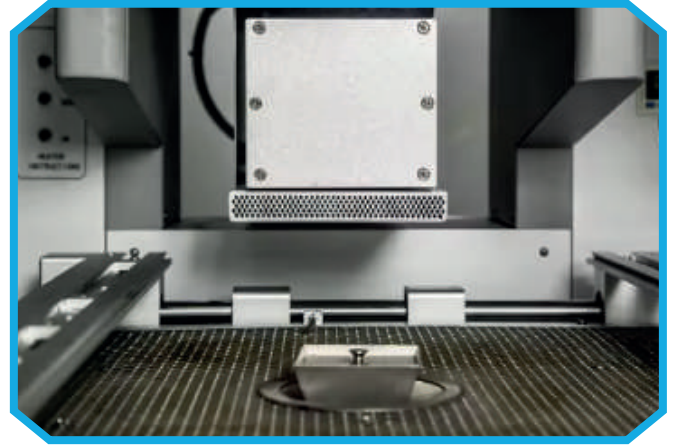
Bottom Heating System

The medium-wave ceramic infrared heating plate imported from Germany is adopted, and the bottom temperature zone can be independently heated to adjust the distance from the PCB. Fast temperature rise and high temperature control accuracy can effectively solve PCBA preheating and rework temperature.



Smoke Purification System

The built-in three-level smoke purification system can filter and purify the toxic gas generated in the work, effectively protecting the environment.



Product Parameters

Model No.	HR-785A
Power Supply	AC380V±10% 50/60HZ
Power	9.85KW(Max), Top heater(1.45KW) Bottom heater (1.2KW), IR Preheater (6.6KW), Other(0.6KW)
PCB Size	635×520mm(Max);6×6mm(Min)
BGA Chip Size	80×80mm(Max);2*2mm(Min)
IR Heater Size	565×435mm
Motion Control	X/Y/Z
Temperature Sensor	5 PCS
Control System	Industrial PC+ Motion control system
Display System	15" HD industrial display (1080P 16:9)+18.5" SD display
Alignment System	2 Million Pixel HD digital imaging system, automatic optical zoom with laser red-dot indicator
Vacuum Adsorption	Automatic
Alignment Accuracy	±0.01mm
Temperature Control	K-type thermocouple closed-loop control with accuracy up to ±1°C
Feeding Device	Yes
Positioning	V-groove with universal fixture (shaped fixture can be customized)
Dimensions	L835×W960×H1640mm
Weight	218.5KG

Optical Alignment Module

CCD (2m pixels) optical alignment system, through the PC control system X/Y automatically move the optical lens alignment, using 15" HD industrial display (1080P 16: g) and 18.5" SD display operation. Equipped with automatic feeding device to realize feeding and receiving automatically.



Optical Alignment Automatic Rework Equipment

Excellent Performance Features

- Multilingual menu interface.
- Automatic feeding device.
- X/Y axis can be controlled by joystick, operation is quick and convenient.
- Imported high-definition CCD (2m pixels) optical alignment system.
- High-precision temperature control sensing system.

X/Y/Z Axis Automatic Displacement

The top temperature zone of the Laser SMD Rework Station is controlled by the joystick control servo system, which can automatically move and align at fast/slow speed by X/Y/Z Axis.



Vacuum Adsorption and Nitrogen Protection

The top heating head has a built-in vacuum suction nozzle for chip adsorption, electrically controlled 360-degree rotation alignment, with negative pressure monitoring and pressure protection device. The bottom temperature zone of the Laser SMD Rework Station adopts a large-area heating wire layout, moves symmetrically with the top temperature zone, and can be connected with nitrogen to prevent PCBA from yellowing.



Product Parameters

Model No.	HR-783A
Power Supply	AC380V±10% 50/60HZ
Power	7.15KW(Max), Top heater(1.45KW), Bottom heater (1.2KW), IR Preheater (4KW), Other(0.5KW)
PCB Size	565×467mm(Max); 6×6mm(Min)
BGA Chip Size	80×80mm(Max); 2×2mm(Min)
IR Heater Size	500×380mm
Motion Control	X/Y/Z
Temperature Sensor	5 PCS
Operation Method	8" HD touch panel
Control System	Panasonic PLC + Temperature control module
Display System	15" HD industrial display (1080P 16:9)
Alignment System	2 Million Pixel HD digital imaging system, automatic optical zoom with laser red-dot indicator
Vacuum Adsorption	Automatic
Temperature Control	K-type thermocouple closed-loop control with accuracy up to ±1°C
Feeding Device	Yes
Positioning	V-groove with universal fixture
Dimensions	L810×W1100×H960mm
Weight	151KG

Automatic Optical Alignment Rework Equipment

HD Optical Alignment and Intelligent Control

Equipped with automatic feeding device, using Panasonic PLC and high-precision temperature control module, high-precision K-type thermocouple, dynamic PID multi-loop closed-loop control selective reflow soldering process, the accuracy can reach $\pm 1^{\circ}\text{C}$. Over temperature protection alarm function, software encryption and foolproof function.

Stable Temperature Control

Three temperature zones independently control, heated by convection hot air, the height of the bottom temperature zone is adjustable, the top temperature zone has a built-in vacuum suction nozzle for chip adsorption, with negative pressure monitoring and pressure protection device.

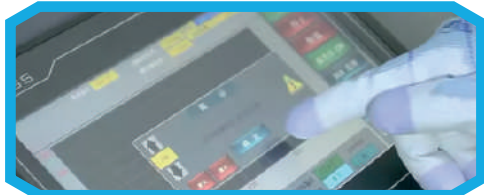
Mobile Infrated Temperature Zone

The IR preheating zone is heated by a carbon fiber infrared tube and protected by a high-temperature resistant microcrystalline panel. It can move left and right to facilitate maintenance of large and irregular PCBA.



Large HD Touch Screen

Large HD touch screen operation with a variety of operation modes, real-time display, and edit temperature curve, each group of temperature curve can be set to 8 segments, can store 100 groups of temperature curve, can automatically analyze the curve, read through touch screen control.



Product Parameters

Model No.	HR-730A
Power Supply	AC380V \pm 10% 50/60HZ
Power	7.75KW(Max), Top heater(1.45KW) Bottom heater (1.2KW), IR Preheater (4.8KW), Other(0.3KW)
PCB Size	632 \times 520mm(Max); 6 \times 6mm(Min)
BGA Chip Size	80 \times 80mm(Max); 3 \times 3mm(Min)
IR Heater Size	570 \times 435mm
Temperature Sensor	5 PCS
Operation Method	10" HD touch panel (1080P 16:9)
Control System	Panasonic PLC + Temperature control module
Display System	15" HD industrial display (1080P 16:9)
Alignment System	2 Million Pixel HD digital imaging system, automatic optical zoom with laser red-dot indicator
Vacuum Adsorption	Automatic
Alignment Accuracy	\pm 0.01mm
Temperature Control	K-type thermocouple closed-loop control with accuracy up to $\pm 1^{\circ}\text{C}$
Feeding Device	Yes
Positioning	V-groove with universal fixture
Dimensions	L1000 \times W835 \times H960mm
Weight	130.5KG



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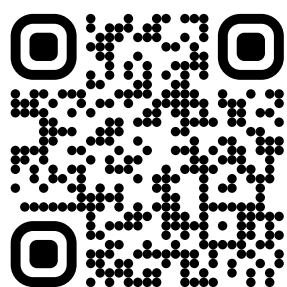
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